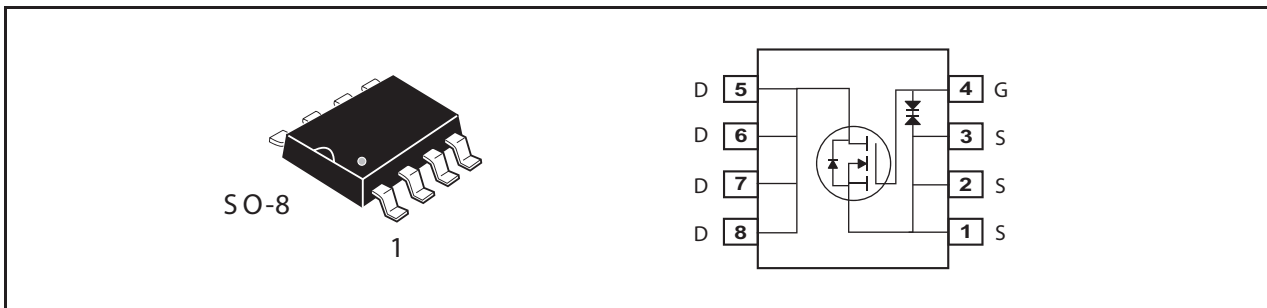


**N-Channel Enhancement Mode Field Effect Transistor**

| PRODUCT SUMMARY | | |
|------------------|----------------|------------------------------|
| V _{DSS} | I _D | R _{DS(ON)} (mΩ) Max |
| 30V | 17.8A | 5 @ V _{GS} =10V |
| | | 7.5 @ V _{GS} =4.5V |

FEATURES

- Super high dense cell design for low R_{DS(ON)}.
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.

**ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)**

| Symbol | Parameter | Limit | Units |
|-----------------------------------|--|----------------------|-------|
| V _{DS} | Drain-Source Voltage | 30 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D | Drain Current-Continuous ^a | T _A =25°C | 17.8 |
| | | T _A =70°C | 14.2 |
| I _{DM} | -Pulsed ^b | 89 | A |
| E _{AS} | Single Pulse Avalanche Energy ^d | 289 | mJ |
| P _D | Maximum Power Dissipation ^a | T _A =25°C | 2.5 |
| | | T _A =70°C | 1.6 |
| T _J , T _{STG} | Operating Junction and Storage Temperature Range | -55 to 150 | °C |

THERMAL CHARACTERISTICS

| | | | |
|------------------|--|----|------|
| R _{θJA} | Thermal Resistance, Junction-to-Ambient ^a | 50 | °C/W |
|------------------|--|----|------|

STM4886E

Ver 1.0

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|---|---|--|-----|-------|-----|-------|
| OFF CHARACTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =24V , V _{GS} =0V | | | 1 | uA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} = ±20V , V _{DS} =0V | | | ±10 | uA |
| ON CHARACTERISTICS | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250uA | 1 | 1.8 | 3 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =10V , I _D =17.8A | | 4 | 5 | m ohm |
| | | V _{GS} =4.5V , I _D =14.5A | | 5.5 | 7.5 | m ohm |
| g _{FS} | Forward Transconductance | V _{DS} =5V , I _D =17.8A | | 55 | | S |
| DYNAMIC CHARACTERISTICS ° | | | | | | |
| C _{ISS} | Input Capacitance | V _{DS} =15V, V _{GS} =0V f=1.0MHz | | 3570 | | pF |
| C _{OSS} | Output Capacitance | | | 640 | | pF |
| C _{RSS} | Reverse Transfer Capacitance | | | 560 | | pF |
| SWITCHING CHARACTERISTICS ° | | | | | | |
| t _{D(ON)} | Turn-On Delay Time | V _{DD} =15V I _D =1A V _{GS} =10V R _{GEN} = 6 ohm | | 68 | | ns |
| t _r | Rise Time | | | 102 | | ns |
| t _{D(OFF)} | Turn-Off Delay Time | | | 170 | | ns |
| t _f | Fall Time | | | 68 | | ns |
| Q _g | Total Gate Charge | V _{DS} =15V, I _D =17.8A, V _{GS} =10V | | 68 | | nC |
| | | V _{DS} =15V, I _D =17.8A, V _{GS} =4.5V | | 32 | | nC |
| Q _{gs} | Gate-Source Charge | V _{DS} =15V, I _D =17.8A, V _{GS} =10V | | 7 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 19 | | nC |
| DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS | | | | | | |
| I _S | Maximum Continuous Drain-Source Diode Forward Current | | | | 10 | A |
| V _{SD} | Diode Forward Voltage | V _{GS} =0V, I _S =10A | | 0.795 | 1.2 | V |

Notes

- Surface Mounted on FR4 Board, t ≤ 10sec.
- Pulse Test: Pulse Width ≤ 300us, Duty Cycle ≤ 2%.
- Guaranteed by design, not subject to production testing.
- Starting T_j=25°C, L=0.5mH, V_{DD}=20V, V_{GS}=10V. (See Figure13)

Jan,26,2010

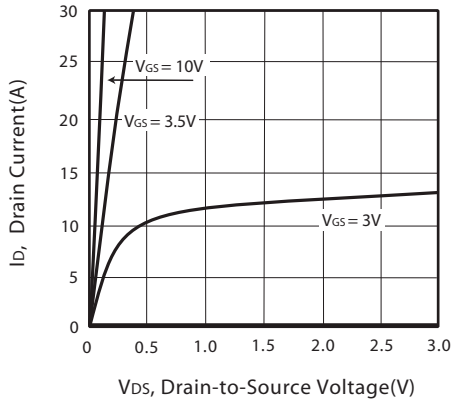


Figure 1. Output Characteristics

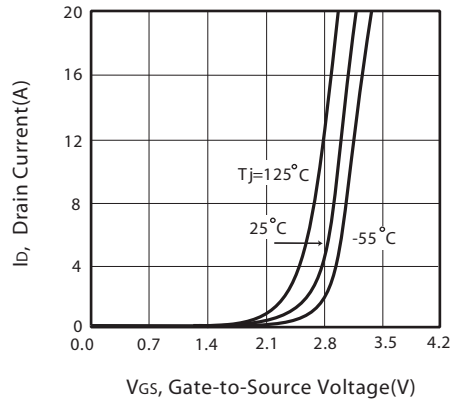


Figure 2. Transfer Characteristics

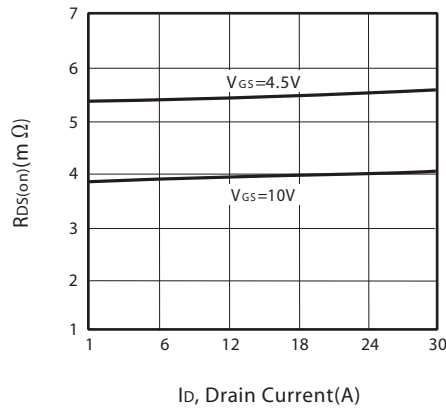


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

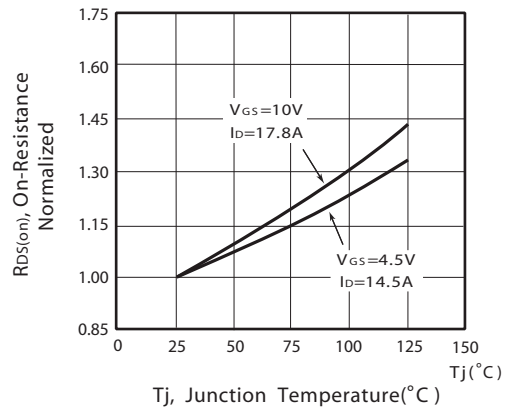


Figure 4. On-Resistance Variation with Drain Current and Temperature

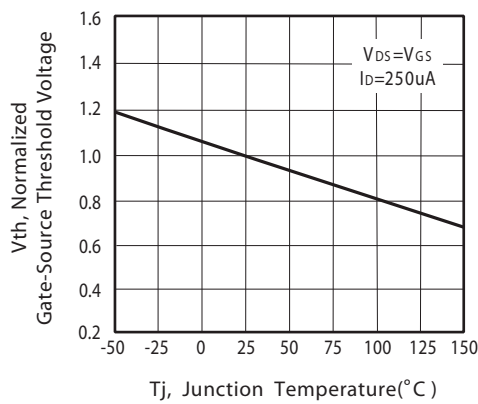


Figure 5. Gate Threshold Variation with Temperature

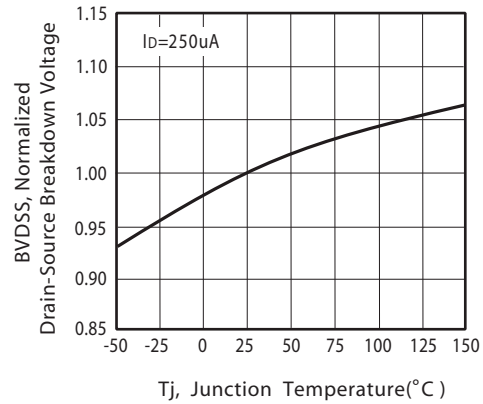


Figure 6. Breakdown Voltage Variation with Temperature

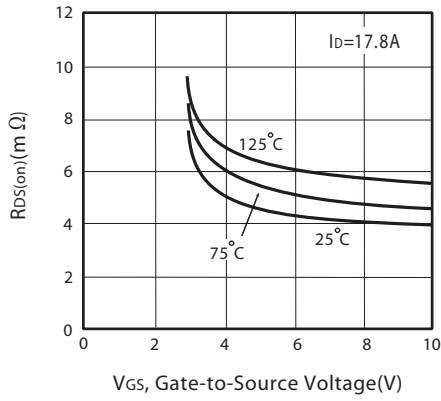


Figure 7. On-Resistance vs. Gate-Source Voltage

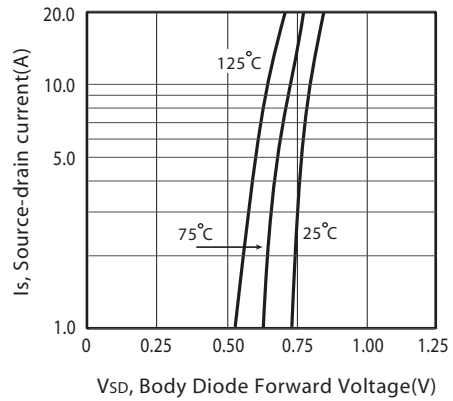


Figure 8. Body Diode Forward Voltage Variation with Source Current

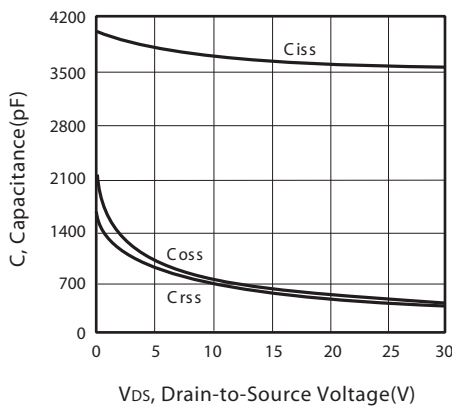


Figure 9. Capacitance

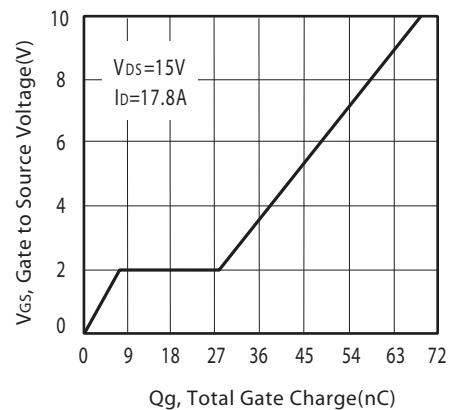


Figure 10. Gate Charge

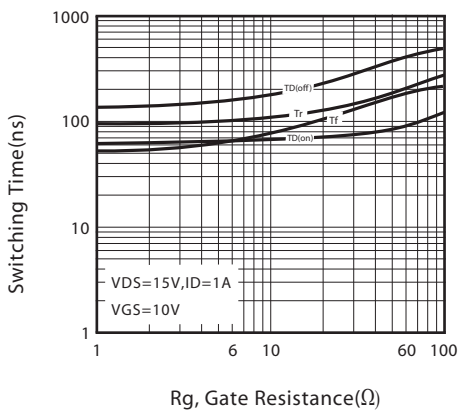


Figure 11. switching characteristics

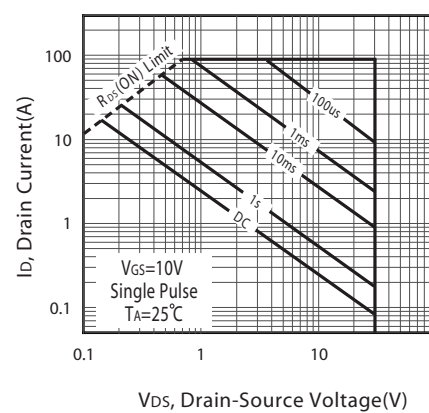
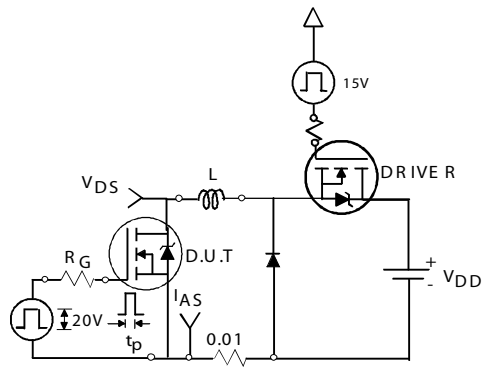
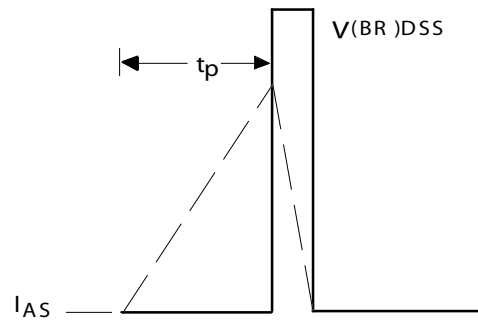


Figure 12. Maximum Safe Operating Area



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

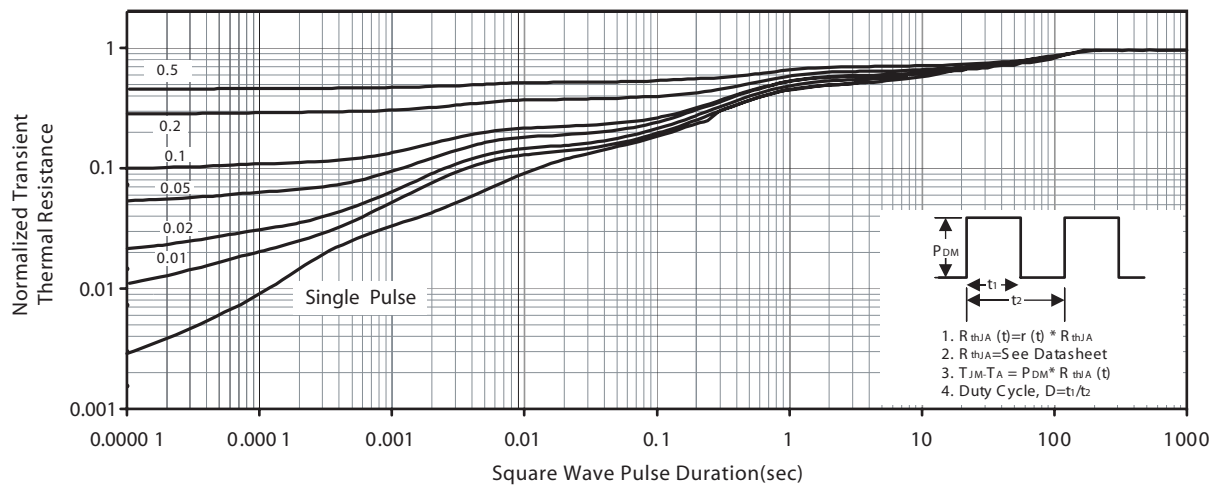
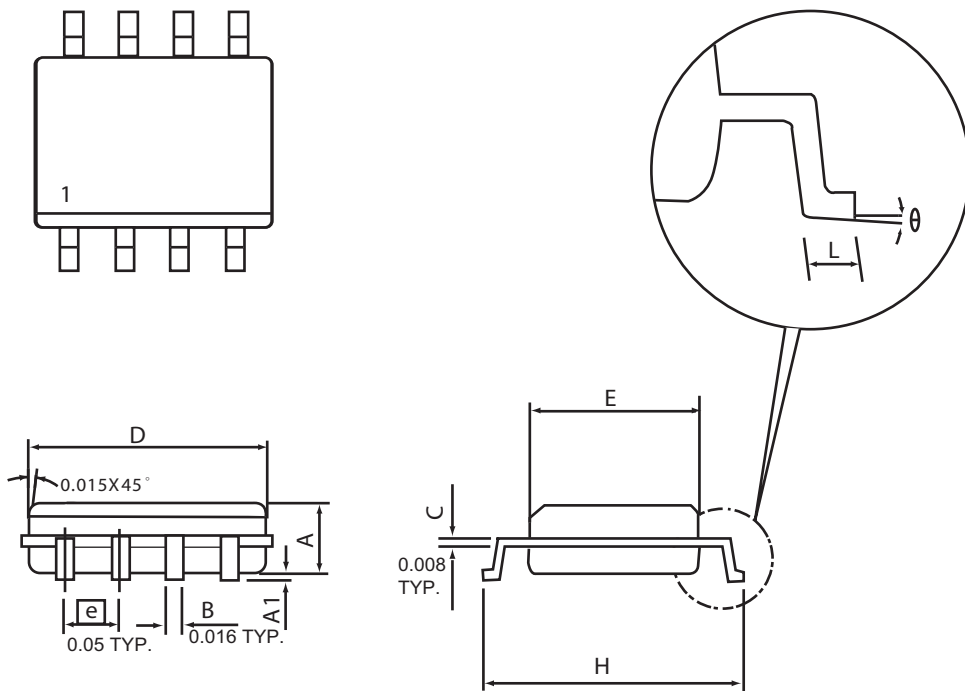


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

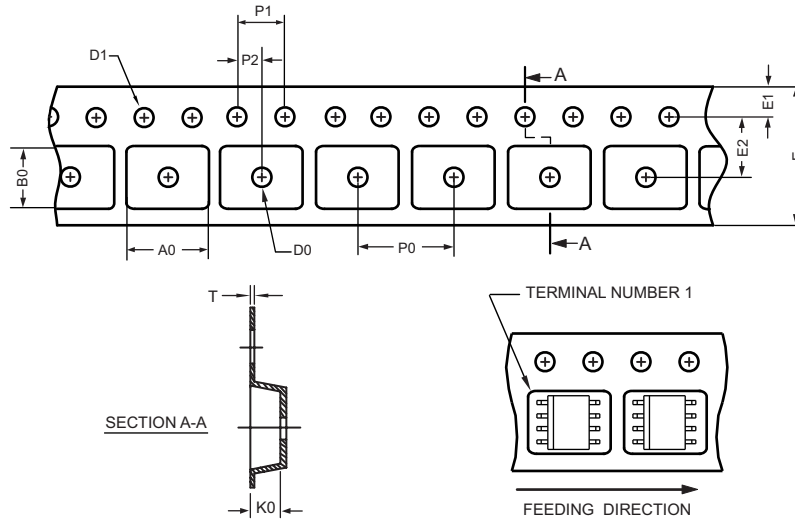
SO-8



| SYMBOLS | MILLIMETERS | | INCHES | |
|---------|-------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| D | 4.80 | 4.98 | 0.189 | 0.196 |
| E | 3.81 | 3.99 | 0.150 | 0.157 |
| H | 5.79 | 6.20 | 0.228 | 0.244 |
| L | 0.41 | 1.27 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

SO-8 Tape and Reel Data

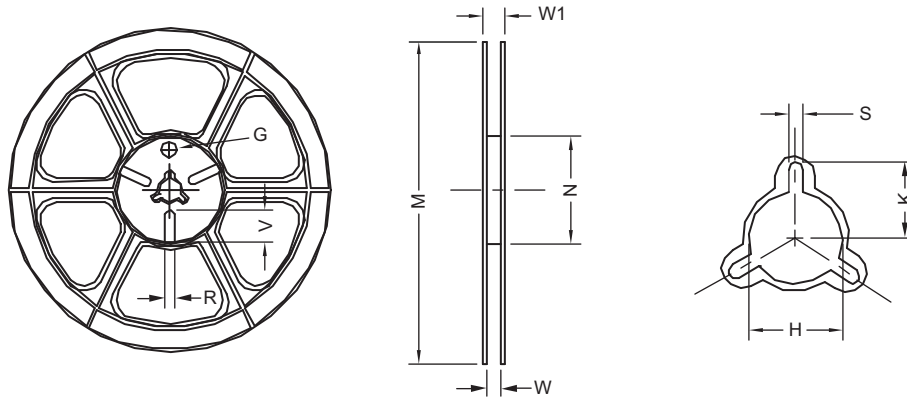
SO-8 Carrier Tape



unit:mm

| PACKAGE | A0 | B0 | K0 | D0 | D1 | E | E1 | E2 | P0 | P1 | P2 | T |
|------------------|---------------|---------------|---------------|----------------|-----------------|----------------------|---------------|--------------|--------------|--------------|--------------|----------------|
| SOP 8N 150mil | 6.50 ±0.15 | 5.25 ±0.10 | 2.10 ±0.10 | φ 1.5 (MIN) | φ 1.55 ±0.10 | 12.0 +0.3 -0.1 | 1.75 ±0.10 | 5.5 ±0.10 | 8.0 ±0.10 | 4.0 ±0.10 | 2.0 ±0.10 | 0.30 ±0.013 |

SO-8 Reel



UNIT:mm

| TAPE SIZE | REEL SIZE | M | N | W | W1 | H | K | S | G | R | V |
|-----------|-----------|------------|------------|--------------|---------------|-------------------|-----|--------------|-----|-----|-----|
| 12 mm | φ 330 | 330 ± 1 | 62 ±1.5 | 12.4 +0.2 | 16.8 - 0.4 | φ 12.75 + 0.15 | --- | 2.0 ±0.15 | --- | --- | --- |